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IN THE U.S. PATENT AND TRADEMARK OFFICE

In re application of

Kiyohito HIROMITSU et al. Conf. 2651

Application No. 10/537,358 Group 1796

Filed June 3, 2005 Examiner G. Webb

MOLD CLEANING MATERIAL AND MOLD CLEANING METHOD

AFTER FINAL AMENDMENT AND REPLY UNDER 37 C.F.R. S 1.116

Assistant Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

December 9, 2008

Sir:

In response to the final Office Action of November 4, 2008, Applicants herein provide the following amendments and remarks.

Amendments to the Specification begin on page 2 of this paper.

Amendments to the Claims are reflected in the listing of claims which begin on page 3 of this paper.

Remarks begin on page 7 of this paper.

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